



Eleprint
Capability
& Design
rules



PRINTED CIRCUIT BOARDS PRODUCTION CAPABILITY

ELEPRINT 2022		
	PRODUCTION	PROTOTYPE
INNER LAYER		
Tracks	65µm	40µm
Insulation	65µm	40µm
OUTER LAYER		
Tracks	75µm	65µm
Insulation	75µm	65µm
LASER VIA PADS		
External	250µm	230µm
Internal	250µm	230µm
MECHANICAL VIA PADS		
	450µm	400µm
	500µm	450µm
ASPECT RATIO		
	1:11	1:12
SOLDER GAP		
	43	38

PRINTED CIRCUIT BOARDS PRODUCTION CAPABILITY

BOARD THICKNESS

minimum	0,10 mm
maximum	6 mm

INNER LAYER LAMINATE THICKNESS

minimum	0,05 mm
maximum	2,40 mm

PREPREG THICKNESS

Type 7628 FR4	0,190 mm
Type 106 FR4	0,055 mm
Type 1080 FR4	0,075 mm
Type 2116 FR4	0,115 mm

COPPER THICKNESS

9 μm (1/4 oz)	On request only UL certified
12 μm (1/3 oz)	YES
17 μm (1/2 oz)	YES
35 μm (1 oz)	YES
50 μm	YES
70 μm	YES
105 μm	YES
> 105 μm	On request only UL certified

PRINTED CIRCUIT BOARDS PRODUCTION CAPABILITY

Hole copper plating (nominal copper thickness)

Via hole	25 μm
Blind via holes	15 μm

Maximum Aspect Ratio

laminare thickness: Hole diameter	Aspect Ratio 12:1 for PTH via hole Aspect Ratio 1:1 for laser via hole
-----------------------------------	---------------------------------------------------------------------------

Surface Treatment

Hot air levelling	1-30 μm
Electroless nickel/gold	Nickel 3-6 μm Gold 0,05-0,07 μm
Immersion tin	1 μm typically
Hard gold	Nickel 4 μm minimum Gold 0,8-1,2 μm
Immersion silver	0,2-0,5 μm

Routing

minimum distance routing to pattern	Inner layers 400 μm Outers layers 200 μm
-------------------------------------	-------------------------------------------------------------------

PRINTED CIRCUIT BOARDS PRODUCTION CAPABILITY

Minimum pad diameter

Inner layers	\emptyset hole + 250 μm
Outers layers	\emptyset hole + 200 μm

Minimum finished hole diameter


Mechanical drilled	> 150 μm
Laser drilled	0,1 ÷ 0,35 μm

Tolerances

PTH holes	- 50 μm \pm +100 μm
no PTH holes	\pm 50 μm
Routing	\pm 100 μm

PRINTED CIRCUIT BOARDS PRODUCTION CAPABILITY

Scoring	
Minimum positioning tolerance	100 μm
Angle	30°
Tolerance to routing	+225 μm 200 μm
Contour tolerance	+150 μm 100 μm
PCB tolerance, 2 scored edges after separation	+ 200 μm - 100 μm
Minimum distance nominal centerline to pattern/holes	500 μm

Marking	
Week Code	2 digits for weeks 2 digits for year (Prototype: WW-YY)
UL Marking	UL Flammability code
Manufacturer Identification	ZPMV8.E135333 ZPMV2.E135333
Marking Sequence (Eleprint manufacturer identification, PCB Type, UL logo)	Example: 



Contatti

ELEPRINT Srl

Via degli Artigiani, 29
23874 Montevecchia (LC) - Italy
Phone: +39 039 999 141
eleprint.it

HEADQUARTERS

ELEMASTER SpA

Tecnologie Elettroniche

Via Garcia Lorca, 29
23871 Lomagna (LC) - Italy
Phone: +39 039 999 121
elemaster.com